

# United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/698,725	10/30/2003	Hubert Allen Vander Plas	10018559-2	1592
7.	590 03/15/2005		EXAM	INER
HEWLETT-PACKARD COMPANY			POTTER, ROY KARL	
Intellectual Pro P.O. Box 2724	perty Administration 00		ART UNIT	PAPER NUMBER
Fort Collins, CO 80527-2400			2822	
			DATE MAILED: 03/15/2005	

Please find below and/or attached an Office communication concerning this application or proceeding.

			$(\omega)$
	Application No.	Applicant(s)	
	10/698,725	PLAS ET AL.	
Office Action Summary	Examiner	Art Unit	
•	Roy K. Potter	2822	
The MAILING DATE of this communication Period for Reply	appears on the cover sheet w	vith the correspondence addre	ss
A SHORTENED STATUTORY PERIOD FOR RETHE MAILING DATE OF THIS COMMUNICATION  - Extensions of time may be available under the provisions of 37 CF after SIX (6) MONTHS from the mailing date of this communication  - If the period for reply specified above is less than thirty (30) days, and if NO period for reply is specified above, the maximum statutory period for reply within the set or extended period for reply will, by some Any reply received by the Office later than three months after the meaned patent term adjustment. See 37 CFR 1.704(b).	ON. R 1.136(a). In no event, however, may a n. a reply within the statutory minimum of thi eriod will apply and will expire SIX (6) MO tatute, cause the application to become A	reply be timely filed  rty (30) days will be considered timely.  NTHS from the mailing date of this commit  BANDONED (35 U.S.C. § 133).	unication.
Status			
1) Responsive to communication(s) filed on 1	10/30/2003 - the Preliminary A	Amendment.	
<u> </u>	This action is non-final.		
3) Since this application is in condition for allo closed in accordance with the practice und		•	erits is
Disposition of Claims			
4) ☐ Claim(s) 13-20 is/are pending in the application Papers	drawn from consideration.		
9) The specification is objected to by the Exar	niner		
10) The drawing(s) filed on is/are: a)		by the Examiner.	
Applicant may not request that any objection to		·	
Replacement drawing sheet(s) including the co	• • • • • • • • • • • • • • • • • • • •		I. <b>121(d)</b> .
11)☐ The oath or declaration is objected to by the	e Examiner. Note the attache	d Office Action or form PTO-	152.
Priorit <u>y</u> under 35 U.S.C. § 119	·		
12) Acknowledgment is made of a claim for force a) All b) Some * c) None of:  1. Certified copies of the priority docum 2. Certified copies of the priority docum 3. Copies of the certified copies of the application from the International But * See the attached detailed Office action for a	nents have been received. nents have been received in priority documents have been priority documents have been	Application No  n received in this National Sta	ge
Attachment(s)	1		
1) ⊠ Notice of References Cited (PTO-892) 2) □ Notice of Draftsperson's Patent Drawing Review (PTO-948		Summary (PTO-413) (s)/Mail Date	
Information Disclosure Statement(s) (PTO-1449 or PTO/SE Paper No(s)/Mail Date	<i>'</i> — — — — — — — — — — — — — — — — — — —	Informal Patent Application (PTO-15	2)

### **DETAILED ACTION**

Claims 13-20 are pending.

## Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 13 – 14 are rejected under 35 U.S.C. 102(b) as being anticipated by Akram.

Akram, U.S. Patent No. 5736456, discloses a method of forming conductive bumps on a die for flip-chip applications. As shown in Figure 4e, the device formed comprises a substrate 56 having a substantially [planar surface and an interior sloped surface. A wettable layer 72 is adhered to the interior sloped surface. A solder layer 82 is adhered to the wettable layer. The wettable layer is metal, as described in column 6, line 6.

In column 6, line 37, Akram explains that the colder layer 82 may be formed by any known technique. The composition of the solder is not disclosed.

# Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 18 and 19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Akram in view of Hubbard.

In regard to claims 18 and 19, these claims recite specific solder compositions.

Claim 18 recites a tin-bismuth compound and claim 19 recites a eutectic tin-lead compound. Akram does not disclose that the solder is made of this material.

Hubbard, UY.S. Patent No. 6168973, discloses a semiconductor stacked device.

As described in column 9, beginning on line 45 "solder materials include eutectic

Sn/Pb.... or any other alloys of commonly used elements such as tin (Sn), lead (Pb),

silver (Ag), bismuth (Bi), indium (In), antimony (Sb), and cadmium (Cd). "

It would have been obvious at the time the invention was made to make the solder in the Akram structure of these materials as Hubbard teaches that these materials are known for use as solders in semiconductor device.

## Allowable Subject Matter

Claims 15 – 17 and 20 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Art Unit: 2822

In regard to claims 15 - 17, the prior art does not teach or suggest coating adhered to a part of the wettable layer as recited.

In regard to claim 20, the prior art does not teach or suggest the recited organic film adhered to a portion of the sloped surface and to a portion of the planar surface of the substrate.

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Roy K. Potter whose telephone number is 571 272 1842. The examiner can normally be reached on M-F.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Roy K Potter Primary Examiner Art Unit 2822